

Mechanical structures for electronic equipment — Terminology

(Implementation of
CENELEC HD 550 S1)

UDC 621.3.049.7:620.17:001.4

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Committees responsible for this British Standard

The preparation of this British Standard was entrusted by the Electronic Components Standards Policy Committee (ECL/-) to Technical Committee ECL/21, upon which the following bodies were represented:

- British Telecommunications plc
- Electronic Components Industry Federation
- EEA (The Association of Electronics Telecommunications and Business Equipment Industries)
- Ministry of Defence
- National Supervising Inspectorate
- Society of British Aerospace Companies Ltd.

The following bodies were also represented in the drafting of the standard, through subcommittees and panels:

- Association of manufacturers allied to the electrical and electronic industry (BEAMA Ltd)

This British Standard, having been prepared under the direction of the Electronic Components Standards Policy Committee, was published under the authority of the Standards Board and comes into effect on 15 March 1994

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National foreword

This British Standard has been prepared under the direction of the Electronic Components Standards Policy Committee. It implements Harmonization Document HD 550 S1:1989, which was published by the European Committee for Electrotechnical Standardization (CENELEC). It is identical with IEC 916:1988 *Mechanical structures for electronic equipment — Terminology*, published by the International Electrotechnical Commission (IEC).

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Summary of pages

This document comprises a front cover, an inside front cover, pages i and ii, the HD title page, pages 2 to 9 and a back cover.

This standard has been updated (see copyright date) and may have had amendments incorporated. This will be indicated in the amendment table on the inside front cover.

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English version

Mechanical structures for electronic equipment — Terminology

(IEC 916:1988)

Structures mécaniques pour équipement
électronique —
Terminologie
(CEI 916:1988)

Bauweisen für elektronische Einrichtungen —
Terminologie
(IEC 916:1988)

This Harmonization Document was approved by CENELEC on 1989-11-01. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for implementation of this Harmonization Document on a national level.

Up-to-date lists and bibliographical references concerning national implementation may be obtained on application to the Central Secretariat or to any CENELEC member.

This Harmonization Document exists in three official versions (English, French, German).

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European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

Central Secretariat: rue de Stassart 35, B-1050 Brussels

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